

Electronic Acknowledgement Receipt

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Application Number:	10711503
Confirmation Number:	5502
Title of Invention:	IC PACKAGE HAVING GROUND IC CHIP AND METHOD OF MANUFACTURING SAME
First Named Inventor:	PEI-HAW TSAO
Customer Number:	44045
Filer:	James H. Ortega
Filer Authorized By:	
Attorney Docket Number:	TSMC 2003-1622
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages
1		TSMC2003-1622Responseto FinalOA.pdf	139707	yes	8

	Multipart Description		
	Doc Desc	Start	End
	Amendment After Final	1	1
	Claims	2	4
	Applicant Arguments/Remarks Made in an Amendment	5	8
Warnings:			
Information:			
Total Files Size (in bytes):		139707	
<p>This Acknowledgement Receipt evidences receipt on the noted date by the USPTO of the indicated documents, characterized by the applicant, and including page counts, where applicable. It serves as evidence of receipt similar to a Post Card, as described in MPEP 503.</p> <p><u>New Applications Under 35 U.S.C. 111</u> If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.</p> <p><u>National Stage of an International Application under 35 U.S.C. 371</u> If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.</p>			